BigTwin SuperServer SYS-221BT-DNTR

Key Applications

High-Performance File System, Diskless HPC Clusters, Scale Out All-Flash NVMe Storage, Big Data Analytics and AI,

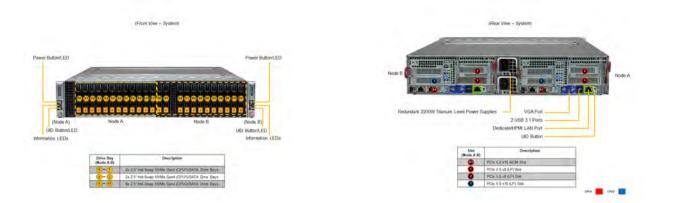
Key Features

- Socket E (LGA 4677) support 4th Gen Intel® Xeon® Scalable processors;
- Intel[®] C741;
- Up to 16 DIMMs ECC DDR5 Slots;
- 1 PCIe 5.0 x16 (LP) slot; 2 PCIe 5.0 x8 (LP) slot; Tool-less support; Optional M.2 NVMe Boot Controller via SCC-A2NM2241G3-B1; Internal PCIe 4.0 x8 for 2 M.2 NVMe support onboard;
- Network connectivity via AIOM (OCP 3.0 compliant);
- 12 hot-Swap 2.5" drive bays (2x PCIe 5.0 NVMe and 10x PCIe 4.0 NVMe/SATA);
- Liquid Cooling Support; 4 cooling fans per 2U enclosure, 16.5K RPM; Shared Cooling Design;
- 2200W Redundant Power Supplies Titanium Level (96%+); Shared Power Design;



Form Factor	2U Rackmount
	Enclosure: 449 x 88 x 730mm (17.68" x 3.47" x 28.75")
	Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")
Processor	4th Gen Intel® Xeon® Scalable processors
	Dual Socket LGA 4677 (Socket E) supported
	Intel Xeon CPU Max Series with high bandwidth memory (HBM)
	(Supports up to 350W TDP CPUs (Aircooled), Supports up to 350W TDP CPUs (Liquid Cooled))
Drive Bays	12x 2.5" hot-swap NVMe/SATA drive bays;
	Optional RAID support via Intel® PCH
Expansion Slots	2 PCIe 5.0 x8 LP slot(s)
	1 PCIe 5.0 x16 LP slot(s)
On-Board Devices	Chipset: Intel [®] C741
	Network Connectivity: Via AIOM
	IPMI: Support for Intelligent Platform Management Interface v.2.0
	IPMI 2.0 with virtual media over LAN and KVM-over-LAN support
Input / Output	LAN: 1 RJ45 Dedicated BMC LAN port
	USB: 2 USB 3.1 port(s) (2 rear)
	Video: 1 VGA port(s)
	Others: 2x M.2 for boot drive or caching
	M.2 form factor: NVMe double-sided 22x110mm
	Note: Enterprise-grade M.2 only for caching application
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System Cooling	4x 16.5K RPM Heavy Duty 8cm Fan(s) Liquid Cooling: Direct to Chip (D2C) Cold Plate (optional)
Power Supply	2200W Redundant Power Supplies with PMBus Dimension (W x H x L): 45 x 40 x 480 mm
System BIOS	BIOS Type: AMI 32MB Flash ROM
Management	SuperDoctor [®] 5; Watch Dog; SUM; IPMI 2.0; KVM with dedicated LAN; SPM; Intel [®] Node Manager; SSM; SuperCloud Composer; Supemicro Out of Band (OOB) License (Included per Node)
PC Health Monitoring	 FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors Temperature: Monitoring for CPU and chassis environment CPU: Monitors for CPU Cores, Chipset Voltages, Memory. 8+4 Phase-switching voltage regulator
Dimensions and Weight	Height: 3.47" (88 mm) Width: 17.68" (449 mm) Depth: 28.75" (730 mm) Gross Weight: 80.7 lbs (36.6 kg) Net Weight: 55.1 lbs (25 kg) Packaging: 9.76" (H) x 24.65" (W) x 45.28" (D) Available Color: Black front & silver body
Operating Environment	ROHS: RoHS Compliant Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -40°C to 60°C (-40°F to 140°F) Operating Relative Humidity: 8% to 90% (Non-Condensing) Non-operating Relative Humidity: 5% to 95% (Non-Condensing)
Motherboard	Super X13DET-B
Chassis	CSE-217BD2-R2K22P